10/538905

JC17 Rec'd PCT/PTO 14 JUN 2005

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express mail in an envelope addressed to: Commissioner of Patents and Trademarks, P. O. Box 1450, ALEXANDRIA, VA 22313-1450, on June 14, 2005. The applicant and/or attorney requests the date of deposit as the filing date. Depositor: by Nicole Barrese

Theore Bavery 6/4/05

Signature & date)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Examiner: not yet assigned

H. Bernhard Pogge et al.

Application No.: not yet assigned

Group Art Unit: not yet assigned

Filed: herewith

For: THREE-DIMENSIONAL DEVICE

Date 6/14/2005

FABRICATION METHOD

INFORMATION DISCLOSURE STATEMENT

The Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to the duty of disclosure set forth in 37 C.F.R. § 1.56, and in accordance with the provisions of 37 C.F.R. §§ 1.97 and 1.98, the undersigned attorney respectfully submits copies of the US patent and publications as listed on Form PTO-1449, attached hereto.

No representation is made or intended as to the pertinency of the disclosed information, that information more pertinent than that listed is not available, or that other information is not applicable.

No fee is believed to be due for this submission. If any fees are required, however, the Commissioner is hereby authorized to charge such fees to Deposit Account No. 09-0458.

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The applicant's undersigned attorney may be reached by telephone at (845) 894-3667.

All correspondence regarding this Information Disclosure Statement should be directed to the below listed address.

Respectfully submitted,

Jay H. Anderson

Attorney for Applicants Registration No. 38,371

INTERNATIONAL BUSINESS MACHINES CORPORATION Intellectual Property Law Department B/321-482 2070 Route 52 Hopewell Junction, New York 12533

Facsimile: (845) 892-6363

INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

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H. Bernhard Pogge et al. Filing Date

Group Art Unit

					herewith			not yet assigned		
				U.S. PAT	ENT DOCUMENTS					
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EXAMINER	R				DATE CONSIDERED	•				
EXAMINE	R: Initi	al if citation considered, whether or	or not citation is in	conforman	ce with MPEP Section 609; [Oraw line throug	gh citation if not	in conform	nance and	

not considered. Include copy of this form with next communication to applicant.

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INF		ATION DISCLOSURE CITATION (Use several sheets if necessary)	Applicant(s) H. Bernhard Pogge et al.	10/9/0/02
			Filing Date herewith	Group Art Unit not yet assigned
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